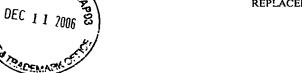
TITLE: METHODS FOR FORMING PROTECTIVE LAYERS ON SEMICONDUCTOR DEVICE COMPONENTS, etc.

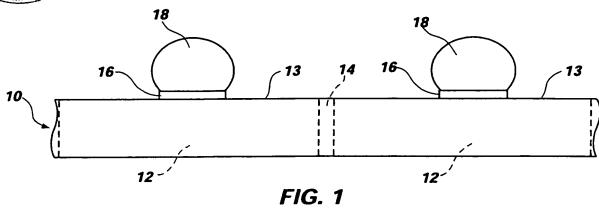
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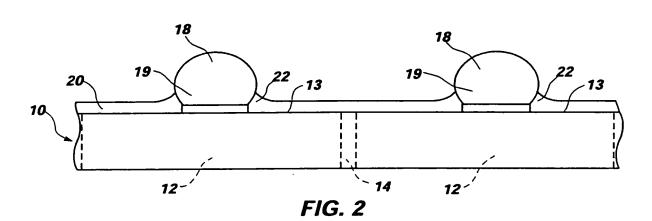
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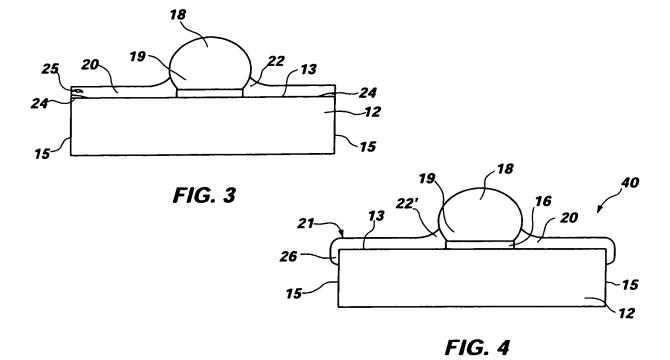
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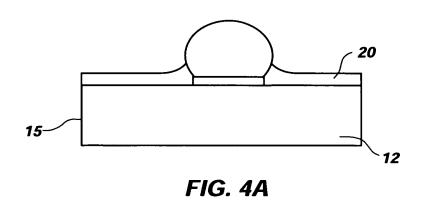


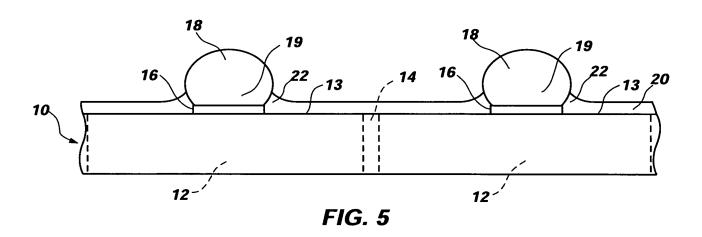


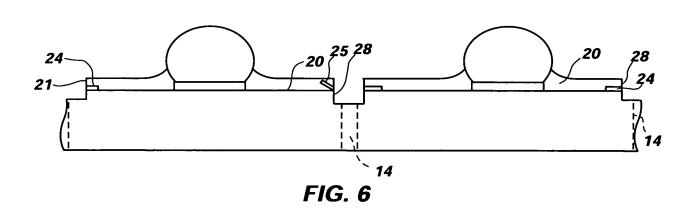


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